FUNCTION TABLE

INPUTS			OUTPUTS	
Σ OF H's AT A THRU H	EVEN	ODD	Σ EVEN	Σ ODD
EVEN	H	L	H	L
ODD	H	L	L	H
EVEN	L	H	L	H
ODD	L	H	H	L
X	H	H	L	L
X	L	L	H	H

H = high level, L = low level, X = irrelevant

SN54180 . . . J OR W PACKAGE
SN74180 . . . N PACKAGE
(TOP VIEW)

```
        G  [ 1   U  14 ]  VCC
        H  [ 2      13 ]  F
     EVEN  [ 3      12 ]  E
      ODD  [ 4      11 ]  D
    ΣEVEN  [ 5      10 ]  C
     ΣODD  [ 6       9 ]  B
      GND  [ 7       8 ]  A
```

description

These universal, monolithic, 9-bit (8 data bits plus 1 parity bit) parity generators/checkers, utilize familiar Series 54/74 TTL circuitry and feature odd/even outputs and control inputs to facilitate operation in either odd or even-parity applications. Depending on whether even or odd parity is being generated or checked, the even or odd inputs can be utilized as the parity or 9th-bit input. The word-length capability is easily expanded by cascading.

The SN54180/SN74180 are fully compatible with other TTL or DTL circuits. Input buffers are provided so that each data input represents only one normalized series 54/74 load. A full fan-out to 10 normalized series 54/74 loads is available from each of the outputs at a low logic level. A fan-out to 20 normalized loads is provided at a high logic level to facilitate the connection of unused inputs to used inputs. Typical power dissipation is 170 mW.

The SN54180 is characterized for operation over the full military temperature range of −55°C to 125°C; and the SN74180 is characterized for operation from 0°C to 70°C.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . 7 V
Input voltage . . . . 5.5 V
Operating free-air temperature range: SN54180 Circuits . . . . −55°C to 125°C
SN74180 Circuits . . . . 0°C to 70°C
Storage temperature range . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	SN54180			SN74180			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			−800			−800	µA
Low-level output current, I_{OL}			16			16	mA
Operating free-air temperature, T_A	−55		125	0		70	°C

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2 TTL Devices

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS[†]	SN54180 MIN	TYP[‡]	MAX	SN74180 MIN	TYP[‡]	MAX	UNIT
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.8			0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = −12 mA			−1.5			−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −800 μA	2.4	3.3		2.4	3.3		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I	Input current at maximum input voltage	V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	High-level input current — Any data input	V_{CC} = MAX, V_I = 2.4 V			40			40	μA
	High-level input current — Even or odd input				80			80	
I_{IL}	Low-level input current — Any data input	V_{CC} = MAX, V_I = 0.4 V			−1.6			−1.6	mA
	Low-level input current — Even or odd input				−3.2			−3.2	
I_{OS}	Short-circuit output current[§]	V_{CC} = MAX	−20		−55	−18		−55	mA
I_{CC}	Supply current	V_{CC} = MAX, See Note 2		34	49		34	56	mA

NOTE 2: I_{CC} is measured with even and odd inputs at 4.5 V, all other inputs and outputs open.
[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.
[§]Not more than one output should be shorted at a time.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER[¶]	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Data	Σ Even	C_L = 15 pF, R_L = 400 Ω, Odd input grounded, See Note 3		40	60	ns
t_{PHL}					45	68	
t_{PLH}	Data	Σ Odd			32	48	ns
t_{PHL}					25	38	
t_{PLH}	Data	Σ Even	C_L = 15 pF, R_L = 400 Ω, Even input grounded, See Note 3		32	48	ns
t_{PHL}					25	38	
t_{PLH}	Data	Σ Odd			40	60	ns
t_{PHL}					45	68	
t_{PLH}	Even or Odd	Σ Even or Σ Odd	C_L = 15 pF, R_L = 400 Ω, See Note 3		13	20	ns
t_{PHL}					7	10	

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

logic symbol[†]
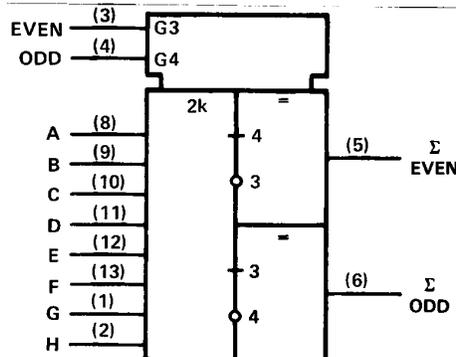
[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

2 TTL Devices

schematics of inputs and outputs

EQUIVALENT OF EACH INPUT

V_{CC}

R_{eq}

INPUT

Data inputs: R_{eq} = 4 kΩ
Even and odd: R_{eq} = 2 kΩ

TYPICAL OF BOTH OUTPUTS

V_{CC}

130 Ω

OUTPUT
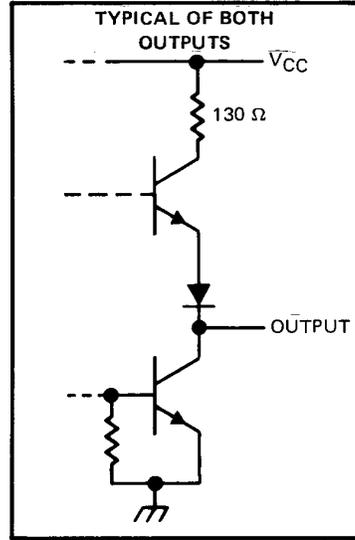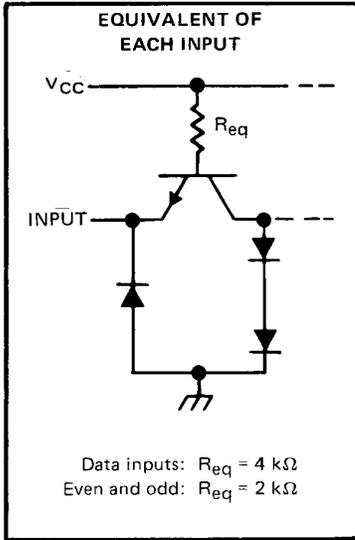
logic diagram (positive logic)

A (8)
B (9)

C (10)
D (11)

DATA INPUTS

E (12)
F (13)

G (1)
H (2)

(5) Σ EVEN OUTPUT

(6) Σ ODD OUTPUT

ODD INPUT (4)

EVEN INPUT (3)

2

TTL Devices

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PACKAGE OPTION ADDENDUM
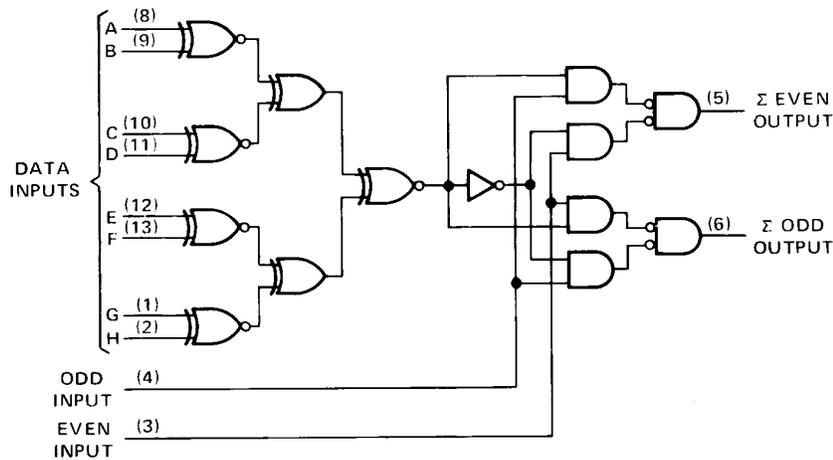
TEXAS INSTRUMENTS

PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
SN54180J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
SN74180N	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74180N	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SNJ54180J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
SNJ54180J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
SNJ54180W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
SNJ54180W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	——	——	——	——
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

B

14   8

1   7

0.065 (1,65)
0.045 (1,14)

C

0.005 (0,13) MIN

0.060 (1,52)
0.015 (0,38)

0.200 (5,08) MAX

Seating Plane

0.130 (3,30) MIN

0.026 (0,66)
0.014 (0,36)

0.100 (2,54)

A

0°−15°

0.014 (0,36)
0.008 (0,20)

4040083/F 03/03

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1−T14, GDIP1−T16, GDIP1−T18 and GDIP1−T20.

W (R–GDFP–F14)   CERAMIC DUAL FLATPACK

Base and Seating Plane

0.045 (1,14)
0.026 (0,66)

0.260 (6,60)
0.235 (5,97)

0.080 (2,03)
0.045 (1,14)

0.006 (0,15)
0.004 (0,10)

0.280 (7,11) MAX

0.019 (0,48)
0.015 (0,38)

1   14

0.050 (1,27)

0.390 (9,91)
0.335 (8,51)

0.005 (0,13) MIN
4 Places

7   8

0.360 (9,14)
0.250 (6,35)

0.360 (9,14)
0.250 (6,35)
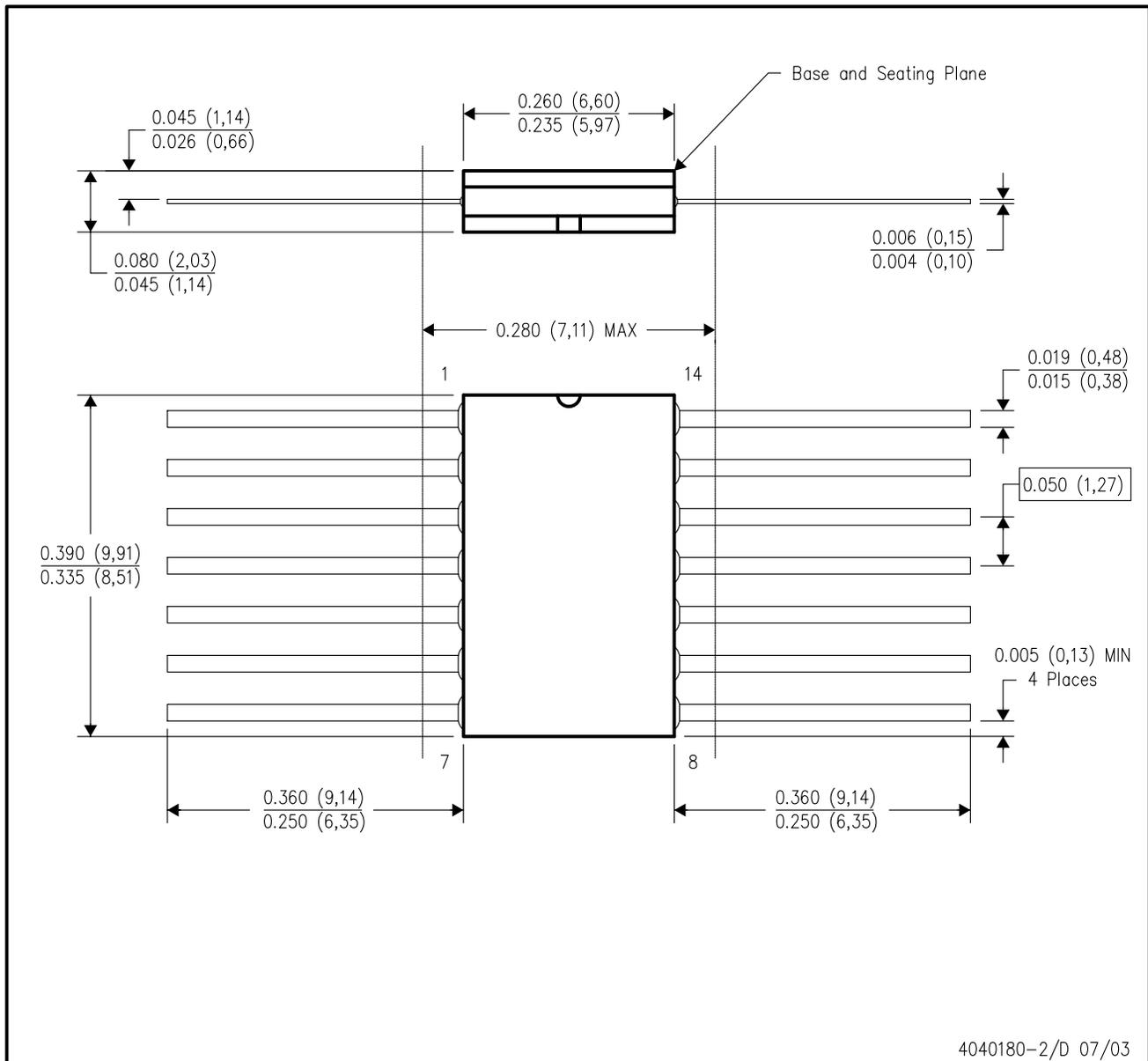
4040180–2/D 07/03

NOTES: A.   All linear dimensions are in inches (millimeters).
         B.   This drawing is subject to change without notice.
         C.   This package can be hermetically sealed with a ceramic lid using glass frit.
         D.   Index point is provided on cap for terminal identification only.
         E.   Falls within MIL STD 1835 GDFP1–F14 and JEDEC MO–092AB

N (R−PDIP−T**)
16 PINS SHOWN

PLASTIC DUAL−IN−LINE PACKAGE

PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS−001 VARIATION	AA	BB	AC	AD

△C

16   A   9

$\dfrac{0.260\ (6,60)}{0.240\ (6,10)}$

1   8

$\dfrac{0.070\ (1,78)}{0.045\ (1,14)}$ △D

$\dfrac{0.045\ (1,14)}{0.030\ (0,76)}$ △D

0.020 (0,51) MIN

0.200 (5,08) MAX

Seating Plane

0.125 (3,18) MIN

0.100 (2,54)

$\dfrac{0.021\ (0,53)}{0.015\ (0,38)}$

⊕ 0.010 (0,25) Ⓜ

14/18 Pin Only
20 Pin vendor option △D

$\dfrac{0.325\ (8,26)}{0.300\ (7,62)}$

0.015 (0,38)

Gauge Plane

0.010 (0,25) NOM

0.430 (10,92) MAX
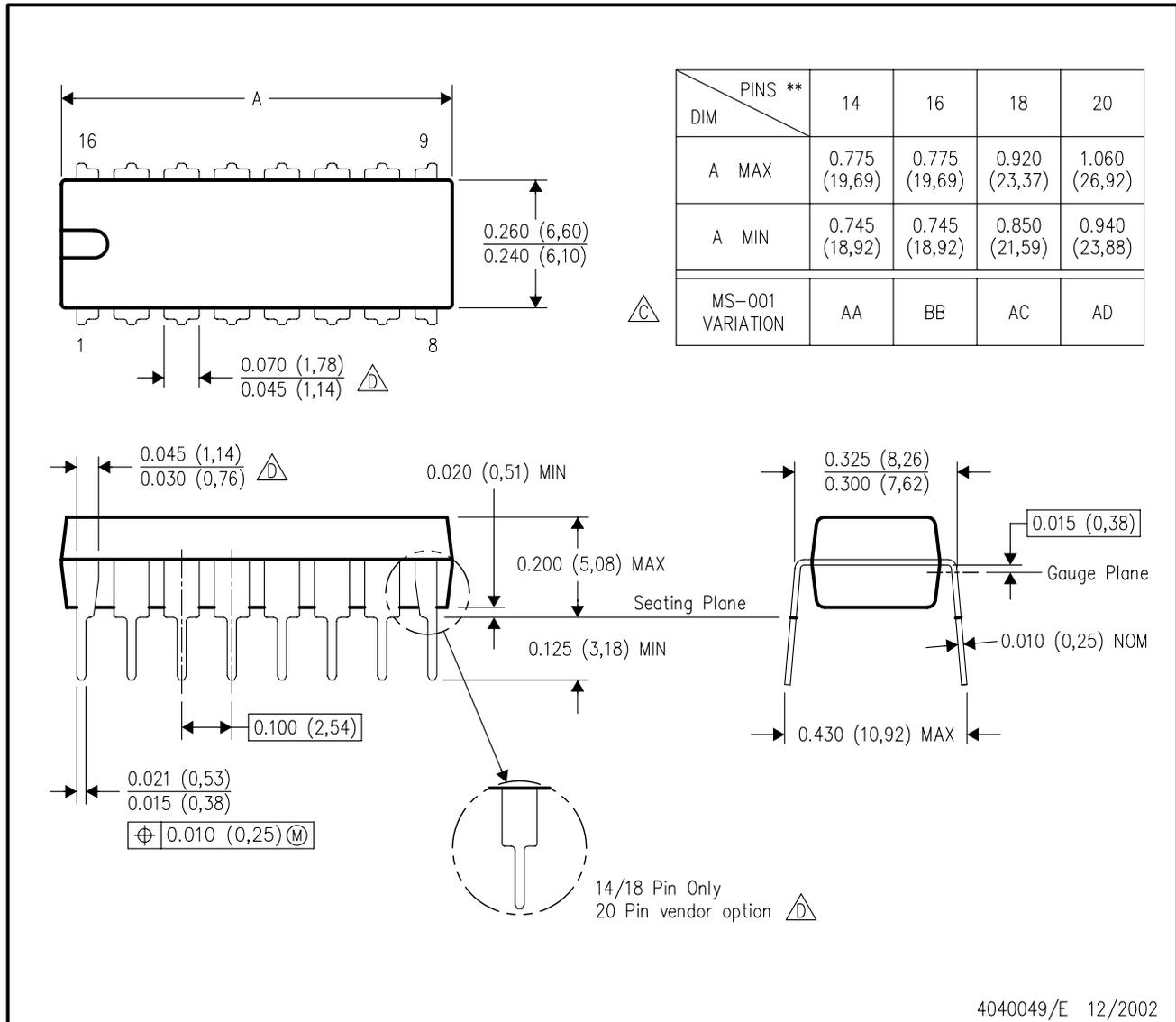
4040049/E 12/2002

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
△C Falls within JEDEC MS−001, except 18 and 20 pin minimum body length (Dim A).
△D The 20 pin end lead shoulder width is a vendor option, either half or full width.

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